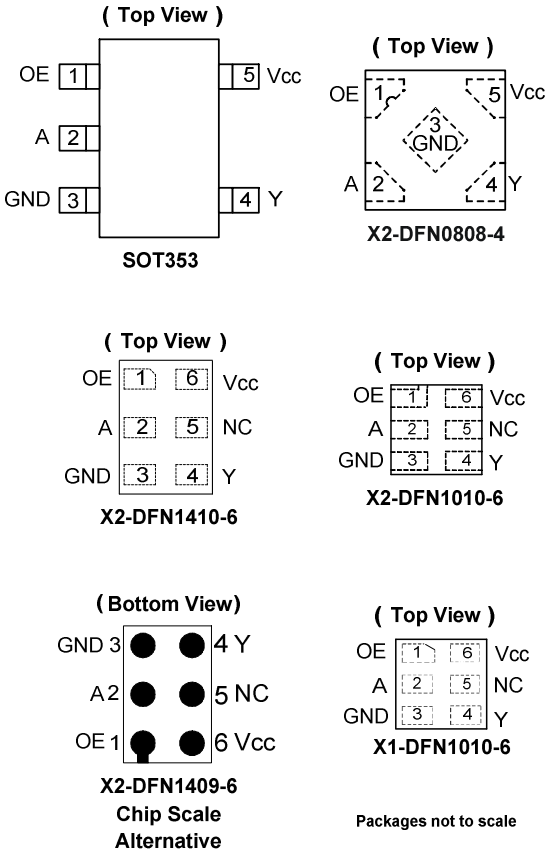
SINGLE BUFFER GATE WITH 3-STATE OUTPUT

Description

The Advanced, Ultra Low Power (AUP) CMOS logic family is designed for low power and extended battery life in portable applications.

The 74AUP1G126 is a single, non-inverting, buffer/bus driver, designed for operation over a power supply range of 0.8V to 3.6V. The device has a three-state output that enters a high-impedance state when a LOW-level is applied to the Output Enable (OE) pin. The device is fully specified for partial power down applications using I_{OFF}. The I_{OFF} circuitry disables the output, preventing damaging current backflow when the device is powered down.

Pin Assignments



Features

- Advanced Ultra Low Power (AUP) CMOS
- Supply Voltage Range from 0.8V to 3.6V
- ±4mA Output Drive at 3.0V
- Low Static Power Consumption
  I_{CC} < 0.9µA
- Low Dynamic Power Consumption
  C_{PD} = 6.3pF (Typical at 3.6V)
- Schmitt Trigger Action at all inputs makes the circuit tolerant for slower input rise and fall time. The hysteresis is typically 250mV at V_{CC} = 3.0V.
- I_{OFF} Supports Partial-Power-Down Mode Operation
- ESD Protection Exceeds JESD 22
  2000-V Human Body Model (A114)
  Exceeds 1000-V Charged Device Model (C101)
- Latch-Up Exceeds 100mA per JESD 78, Class I
- Leadless Packages named per JESD30E
- **Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)**
- **Halogen and Antimony Free. "Green" Device (Note 3)**

Applications

- Suited for Battery and Low Power Needs
- Wide array of products such as:
  - Tablets, E-readers
  - Cell Phones, Personal Navigation / GPS
  - MP3 Players ,Cameras, Video Recorders
  - PCs, Ultrabooks, Notebooks, Netbooks,
  - Computer Peripherals, Hard Drives, CD/DVD ROMs
  - TVs, DVDs, DVRs, Set-Top Boxes

Notes:
1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

Ordering Information

74AUP1G 126 XXX -7

Logic Device	Function	Package	Packing
74 : Logic Prefix AUP : 0.8 to 3.6 V Logic Family 1G : One Gate	126: 3-State Buffer OE active HIGH	SE : SOT353 FS3 : X2-DFN0808-4 FW5 : X1-DFN1010-6 FW4 :X2-DFN1010-6 FX4 : X2- DFN1409-6 FZ4 : X2- DFN1410-6	-7 : 7" Tape & Reel

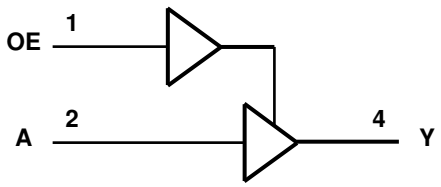
Device	Package Code	Package (Notes 4 & 5)	Package Size	7" Tape and Reel	
				Quantity	Part Number Suffix
74AUP1G126SE-7	SE	SOT353	2.0mm x 2.0mm x 1.1mm 0.65 mm lead pitch	3,000/Tape & Reel	-7
74AUP1G126FS3-7	FS3	X2-DFN0808-4	0.8mm x 0.8mm x 0.35mm 0.5 mm pad pitch (diamond)	5,000/Tape & Reel	-7
74AUP1G126FW5-7	FW5	X1-DFN1010-6	1.0mm x 1.0mm x 0.5mm 0.35 mm pad pitch	5,000/Tape & Reel	-7
74AUP1G126FW4-7	FW4	X2-DFN1010-6	1.0mm x 1.0mm x 0.4mm 0.35 mm pad pitch	5,000/Tape & Reel	-7
74AUP1G126FX4-7	FX4	X2-DFN1409-6 Chip Scale Alternative	1.4mm x 0.9mm x 0.4mm 0.5 mm pad pitch	5,000/Tape & Reel	-7
74AUP1G126FZ4-7	FZ4	X2-DFN1410-6	1.4mm x 1.0mm x 0.4mm 0.5 mm pad pitch	5,000/Tape & Reel	-7

Notes: 4. Pad layout as shown on Diodes Inc. suggested pad layout document AP02001, which can be found on our website at http://www.diodes.com/datasheets/ap02001.pdf.
5. The taping orientation is located on our website at http://www.diodes.com/datasheets/ap02007.pdf.

Pin Descriptions

Pin Name	Function
OE	Output Enable
A	Data Input
GND	Ground
Y	Data Output
V_{CC}	Supply Voltage

Logic Diagram



Function Table

Inputs		Output
OE	A	Y
H	H	H
H	L	L
L	X	Z

Absolute Maximum Ratings (Notes 6 & 7) (@T_A = +25°C, unless otherwise specified.)

Symbol	Description	Rating	Unit
ESD HBM	Human Body Model ESD Protection	2	kV
ESD CDM	Charged Device Model ESD Protection	1	kV
V_{CC}	Supply Voltage Range	-0.5 to +4.6	V
V_I	Input Voltage Range	-0.5 to +4.6	V
V_O	Voltage Applied to Output in High or Low State	-0.5 to V_{CC} +0.5	V
I_{IK}	Input Clamp Current $V_I < 0$	50	mA
I_{OK}	Output Clamp Current ($V_O < 0$)	50	mA
I_O	Continuous Output Current (V_O = 0 to V_{CC})	±20	mA
I_{CC}	Continuous Current Through V_{CC}	50	mA
I_{GND}	Continuous Current Through GND	-50	mA
T_J	Operating Junction Temperature	-40 to +150	°C
T_{STG}	Storage Temperature	-65 to +150	°C

Notes: 6. Stresses beyond the absolute maximum may result in immediate failure or reduced reliability. These are stress values and device operation should be within recommend values.
7. Forcing the maximum allowed voltage could cause a condition exceeding the maximum current or conversely forcing the maximum current could cause a condition exceeding the maximum voltage. The ratings of both current and voltage must be maintained within the controlled range.

Recommended Operating Conditions (Note 8) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter		Min	Max	Unit
V_{CC}	Operating Voltage		0.8	3.6	V
V_I	Input Voltage		0	3.6	V
V_O	Output Voltage		0	V_{CC}	V
I_{OH}	High-Level Output Current	V_{CC} = 0.8V	—	-20	µA
		V_{CC} = 1.1V	—	-1.1	mA
		V_{CC} = 1.4V	—	-1.7	
		V_{CC} = 1.65V	—	-1.9	
		V_{CC} = 2.3V	—	-3.1	
		V_{CC} = 3.0V	—	-4	
I_{OL}	Low-Level Output Current	V_{CC} = 0.8V	—	20	µA
		V_{CC} = 1.1V	—	1.1	mA
		V_{CC} = 1.4V	—	1.7	
		V_{CC} = 1.65V	—	1.9	
		V_{CC} = 2.3V	—	3.1	
		V_{CC} = 3.0V	—	4	
Δt/ΔV	Input Transition Rise or Fall Rate	V_{CC} = 0.8V to 3.6V	—	200	ns/V
T_A	Operating Free-Air Temperature		-40	+125	°C

Note: 8. Unused inputs should be held at V_{CC} or Ground.

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Test Conditions	V_{CC}	T_A = +25°C		T_A = -40°C to +85°C		Unit
				Min	Max	Min	Max	
V_{IH}	High-Level Input Voltage	—	0.8V to 1.65V	0.80 x V_{CC}	—	0.80 x V_{CC}	—	V
		—	1.65V to 1.95V	0.65 x V_{CC}	—	0.65 x V_{CC}	—	
		—	2.3V to 2.7V	1.6	—	1.6	—	
		—	3.0V to 3.6V	2.0	—	2.0	—	
V_{IL}	Low-Level Input Voltage	—	0.8V to 1.65V	—	0.30 x V_{CC}	—	0.30 x V_{CC}	V
		—	1.65V to 1.95V	—	0.35 x V_{CC}	—	0.35 x V_{CC}	
		—	2.3V to 2.7V	—	0.7	—	0.7	
		—	3.0V to 3.6V	—	0.9	—	0.9	
V_{OH}	High-Level Output Voltage	I_{OH} = -20μA	0.8V to 3.6V	V_{CC} – 0.1	—	V_{CC} – 0.1	—	V
		I_{OH} = -1.1mA	1.1V	0.75 x V_{CC}	—	0.7 x V_{CC}	—	
		I_{OH} = -1.7mA	1.4V	1.11	—	1.03	—	
		I_{OH} = -1.9mA	1.65V	1.32	—	1.3	—	
		I_{OH} = -2.3mA	2.3V	2.05	—	1.97	—	
		I_{OH} = -3.1mA		1.9	—	1.85	—	
		I_{OH} = -2.7mA	3V	2.72	—	2.67	—	
		I_{OH} = -4mA		2.6	—	2.55	—	
V_{OL}	Low-Level Output Voltage	I_{OL} = 20μA	0.8V to 3.6V	—	0.1	—	0.1	V
		I_{OL} = 1.1mA	1.1V	—	0.3 x V_{CC}	—	0.3 x V_{CC}	
		I_{OL} = 1.7mA	1.4V	—	0.31	—	0.37	
		I_{OL} = 1.9mA	1.65V	—	0.31	—	0.35	
		I_{OL} = 2.3mA	2.3V	—	0.31	—	0.33	
		I_{OL} = 3.1mA		—	0.44	—	0.45	
		I_{OL} = 2.7mA	3V	—	0.31	—	0.33	
		I_{OL} = 4mA		—	0.44	—	0.45	
I_I	Input Current	A or B Input V_I = GND to 3.6V	0 to 3.6V	—	±0.1	—	±0.5	μA
I_{OFF}	Power Down Leakage Current	V_I or V_O = 0V to 3.6V	0	—	±0.2	—	±0.5	μA
I_{OZ}	Z State Leakage Current	V_O = 3.6V V_i = 3.6V	3.6V	—	±0.2	—	±0.5	μA
ΔI_{OFF}	Delta Power Down Leakage Current	V_I or V_O = 0V to 3.6V	0 to 0.2V	—	0.2	—	0.6	μA
I_{CC}	Supply Current	V_I = GND or V_{CC}, I_O = 0	0.8V to 3.6V	—	0.5	—	0.9	μA
ΔI_{CC}	Additional Supply Current	Data Input at V_{CC} -0.6V OE = GND I_O = 0A	3.3V	—	40	—	50	μA
		OE Input at V_{CC} -0.6V Data Input = GND or Vcc, I_O = 0A	3.3V	—	110	—	120	μA
		OE Input at GND Data Input = GND to 3.6V, I_O = 0A	0.8V to 3.6V	—	1	—	1	μA

Electrical Characteristics (continued) (@T_A = +25°C, unless otherwise specified.)

Symbol	Parameter	Test Conditions	V_{CC}	T_A = -40°C to +125°C		Unit
				Min	Max	
V_{IH}	High-Level Input Voltage	—	0.8V to 1.65V	0.80 x V_{CC}	—	V
		—	1.65V to 1.95V	0.70 x V_{CC}	—	
		—	2.3V to 2.7V	1.6	—	
		—	3.0V to 3.6V	2.0	—	
V_{IL}	Low-Level Input Voltage	—	0.8V to 1.65V	—	0.25 x V_{CC}	V
		—	1.65V to 1.95V	—	0.35 x V_{CC}	
		—	2.3V to 2.7V	—	0.7	
		—	3.0V to 3.6V	—	0.9	
V_{OH}	High-Level Output Voltage	I_{OH} = -20μA	0.8V to 3.6V	V_{CC} – 0.11	—	V
		I_{OH} = -1.1mA	1.1V	0.6 x V_{CC}	—	
		I_{OH} = -1.7mA	1.4V	0.93	—	
		I_{OH} = -1.9mA	1.65V	1.17	—	
		I_{OH} = -2.3mA	2.3V	1.77	—	
		I_{OH} = -3.1mA		1.67	—	
		I_{OH} = -2.7mA	3V	2.40	—	
		I_{OH} = -4mA		2.30	—	
V_{OL}	Low-Level Output Voltage	I_{OL} = 20μA	0.8V to 3.6V	—	0.11	V
		I_{OL} = 1.1mA	1.1V	—	0.3 x V_{CC}	
		I_{OL} = 1.7mA	1.4V	—	0.41	
		I_{OL} = 1.9mA	1.65V	—	0.39	
		I_{OL} = 2.3mA	2.3V	—	0.36	
		I_{OL} = 3.1mA		—	0.50	
		I_{OL} = 2.7mA	3V	—	0.36	
		I_{OL} = 4mA		—	0.50	
I_I	Input Current	A or B Input V_I = GND to 3.6V	0 to 3.6V	—	±0.75	μA
I_{OFF}	Power Down Leakage Current	V_I or V_O = 0V to 3.6V	0	—	±3.5	μA
I_{OZ}	Z State Leakage Current	V_O = 3.6V V_i = 3.6V	3.6V	—	±1.5	μA
ΔI_{OFF}	Delta Power Down Leakage Current	V_I or V_O = 0V to 3.6V	0V to 0.2V	—	±2.5	μA
I_{CC}	Supply Current	V_I = GND or V_{CC}, I_O = 0	0.8V to 3.6V	—	3.0	μA
ΔI_{CC}	Additional Supply Current	Data Input at V_{CC} -0.6V OE = GND I_O = 0A	3.3V	—	75	μA
		OE input at V_{CC} -0.6V Data Input = GND or Vcc, I_O = 0A	3.3V	—	180	μA
		OE Input at GND Data Input = GND to 3.6V, I_O = 0A	0.8V to 3.6V	—	1	μA

Switching Characteristics

C_L = 5pF, See Figure 1

Parameter	From Input	To Output	V_{CC}	T_A = +25°C			T_A = -40°C to +85°C		T_A = -40°C to +125°C		Unit
				Min	Typ	Max	Min	Max	Min	Max	
t_{pd}	A	Y	0.8V	—	20.6	—	—	—	—	—	ns
			1.2V ± 0.1V	2.5	5.5	10.5	2.5	11.7	2.5	12.9	
			1.5V ± 0.1V	2.0	3.9	6.1	2.0	7.3	2.0	8.1	
			1.8V ± 0.15V	1.9	3.2	4.8	1.7	6.1	1.7	6.7	
			2.5V ± 0.2V	1.6	2.6	3.6	1.4	4.3	1.4	4.9	
			3.3V ± 0.3V	1.4	2.4	3.1	1.2	3.9	1.2	4.4	
t_{en}	OE	Y	0.8V	—	71.6	—	—	—	—	—	ns
			1.2V ± 0.1V	2.8	6.2	12.4	2.6	13.6	2.6	13.6	
			1.5V ± 0.1V	2.1	4.2	6.9	2.1	7.4	2.1	7.7	
			1.8V ± 0.15V	1.7	3.3	5.3	1.7	5.9	1.7	6.2	
			2.5V ± 0.2V	1.4	2.4	3.6	1.4	3.8	1.4	4.1	
			3.3V ± 0.3V	1.3	2.0	2.9	1.2	3.2	1.2	3.4	
t_{dis}	OE	Y	0.8V	—	10.3	—	—	—	—	—	ns
			1.2V ± 0.1V	2.6	4.2	8.2	2.6	8.9	2.6	8.9	
			1.5V ± 0.1V	2.1	3.2	6.7	2.1	7.0	2.1	7.0	
			1.8V ± 0.15V	1.7	3.1	6.2	1.7	6.5	1.7	6.5	
			2.5V ± 0.2V	1.3	2.9	5.7	1.3	5.8	1.3	5.8	
			3.3V ± 0.3V	1.2	2.8	4.5	1.2	4.7	1.2	4.7	

C_L = 10pF, See Figure 1

Parameter	From Input	To Output	V_{CC}	T_A = +25°C			T_A = -40°C to +85°C		T_A = -40°C to +125°C		Unit
				Min	Typ	Max	Min	Max	Min	Max	
t_{pd}	A	Y	0.8V	—	24.0	—	—	—	—	—	ns
			1.2V ± 0.1V	2.6	6.4	12.3	2.6	13.8	2.6	15.2	
			1.5V ± 0.1V	2.1	4.5	7.3	2.1	8.5	2.1	9.4	
			1.8V ± 0.15V	1.9	3.8	5.5	1.9	6.8	1.9	7.6	
			2.5V ± 0.2V	1.7	3.2	4.2	1.7	5.3	1.7	5.9	
			3.3V ± 0.3V	1.6	3.0	3.8	1.6	4.6	1.6	5.2	
t_{en}	OE	Y	0.8V	—	75.3	—	—	—	—	—	ns
			1.2V ± 0.1V	3.0	7.1	14.1	3.0	15.4	3.0	15.4	
			1.5V ± 0.1V	2.1	4.8	8.0	2.1	8.3	2.1	8.6	
			1.8V ± 0.15V	1.7	3.9	5.9	1.7	6.5	1.7	6.8	
			2.5V ± 0.2V	1.4	2.9	4.2	1.4	4.5	1.4	4.8	
			3.3V ± 0.3V	1.3	2.6	3.6	1.3	3.8	1.3	4.0	
t_{dis}	OE	Y	0.8V	—	12.2	—	—	—	—	—	ns
			1.2V ± 0.1V	3.3	7.9	10.1	3.3	11.1	3.3	11.1	
			1.5V ± 0.1V	2.1	7.0	9.3	2.1	10.1	2.1	10.1	
			1.8V ± 0.15V	1.7	6.3	8.7	1.7	9.1	1.7	9.1	
			2.5V ± 0.2V	1.4	4.9	7.6	1.4	7.8	1.4	7.8	
			3.3V ± 0.3V	1.3	4.1	5.7	1.3	5.8	1.3	5.8	

Switching Characteristics (continued)

C_L=15pF, See Figure 1

Parameter	From Input	To Output	V_{CC}	T_A = +25°C			T_A = -40°C to +85°C		T_A = -40°C to +125°C		Unit
				Min	Typ	Max	Min	Max	Min	Max	
t_{pd}	A	Y	0.8V	—	27.4	—	—	—	—	—	ns
			1.2V ± 0.1V	3.6	7.2	14.1	3.3	15.8	3.3	17.5	
			1.5V ± 0.1V	3.0	5.1	8.1	2.5	9.8	2.5	10.9	
			1.8V ± 0.15V	2.2	4.3	6.3	2.0	7.9	2.0	8.8	
			2.5V ± 0.2V	2.0	3.7	4.9	1.8	6.0	1.8	6.7	
			3.3V ± 0.3V	2.0	3.5	4.4	1.8	5.4	1.8	6.1	
t_{en}	OE	Y	0.8V	—	79.2	—	—	—	—	—	ns
			1.2V ± 0.1V	3.6	7.8	15.8	3.3	17.1	3.3	17.1	
			1.5V ± 0.1V	3.0	5.4	8.8	2.9	9.4	2.9	9.7	
			1.8V ± 0.15V	2.1	4.3	6.7	2.0	7.3	2.0	7.7	
			2.5V ± 0.2V	1.8	3.4	4.8	1.7	5.2	1.7	5.6	
			3.3V ± 0.3V	1.6	3.1	4.3	1.5	4.5	1.5	4.7	
t_{dis}	OE	Y	0.8V	—	14.9	—	—	—	—	—	ns
			1.2V ± 0.1V	3.7	9.0	12.7	3.7	13.0	3.7	13.0	
			1.5V ± 0.1V	2.5	8.1	11.5	2.5	12.0	2.5	12.0	
			1.8V ± 0.15V	2.0	7.9	10.1	2.0	10.4	2.0	10.4	
			2.5V ± 0.2V	1.7	7.7	9.7	1.7	9.9	1.7	9.9	
			3.3V ± 0.3V	1.5	7.2	9.0	1.5	9.3	1.5	9.3	

C_L=30pF, See Figure 1

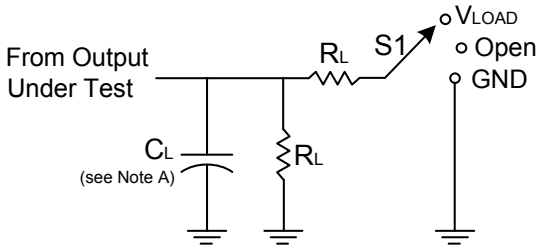
Parameter	From Input	To Output	V_{CC}	T_A = +25°C			T_A = -40°C to +85°C		T_A = -40°C to +125°C		Unit
				Min	Typ	Max	Min	Max	Min	Max	
t_{pd}	A	Y	0.8V	—	37.4	—	—	—	—	—	ns
			1.2V ± 0.1V	4.8	9.5	18.7	4.4	21.4	4.4	24.0	
			1.5V ± 0.1V	4.0	6.7	10.8	3.0	13.0	3.0	14.5	
			1.8V ± 0.15V	2.5	5.6	8.4	2.5	10.3	2.5	11.5	
			2.5V ± 0.2V	2.2	4.8	6.3	2.2	7.8	2.2	8.7	
			3.3V ± 0.3V	2.0	4.6	5.8	2.0	7.0	2.0	8.3	
t_{en}	OE	Y	0.8V	—	90.6	—	—	—	—	—	ns
			1.2V ± 0.1V	4.7	10.0	20.4	4.3	22.0	4.3	22.0	
			1.5V ± 0.1V	3.5	6.9	11.3	3.5	12.0	3.5	12.5	
			1.8V ± 0.15V	2.6	5.6	8.6	3.2	9.5	3.2	10.1	
			2.5V ± 0.2V	2.3	4.5	6.3	2.9	6.8	2.9	7.3	
			3.3V ± 0.3V	2.2	4.2	5.8	2.7	6.4	2.7	6.7	
t_{dis}	OE	Y	0.8V	—	51.6	—	—	—	—	—	ns
			1.2V ± 0.1V	4.7	12.8	15.0	4.7	15.5	4.7	15.5	
			1.5V ± 0.1V	3.0	11.8	13.5	3.0	13.9	3.0	13.9	
			1.8V ± 0.15V	2.6	10.8	12.7	2.6	13.2	2.6	12.7	
			2.5V ± 0.2V	2.3	10.1	12.0	2.3	12.5	2.3	12.5	
			3.3V ± 0.3V	2.2	9.0	11.5	2.2	12.0	2.2	12.0	

Operating and Package Characteristics (@T_A = +25°C, unless otherwise specified.)

Parameter		Test Conditions		V_{CC}	Typ	Unit
C_{pd}	Power Dissipation Capacitance	f = 1MHz No Load		0.8V	6.9	pF
				1.2V ± 0.1V	6.7	
				1.5V ± 0.1V	6.6	
				1.8V ± 0.15V	6.5	
				2.5V ± 0.2V	6.4	
				3.3V ± 0.3V	6.3	
C_i	Input Capacitance	$V_i = V_{CC}$ or GND		0V or 3.3V	1.5	pF
θ_{JA}	Thermal Resistance Junction-to-Ambient	SOT353	(Note 9)	—	371	°C/W
		X2-DFN0808-4		—	430	
		X1-DFN1010-6		—	435	
		X2-DFN1010-6		—	445	
		X2-DFN1409-6		—	470	
		X2-DFN1410-6		—	460	
θ_{JC}	Thermal Resistance Junction-to-Case	SOT353	(Note 9)	—	143	°C/W
		X2-DFN0808-4		—	240	
		X1-DFN1010-6		—	250	
		X2-DFN1010-6		—	250	
		X2-DFN1409-6		—	275	
		X2-DFN1410-6		—	265	

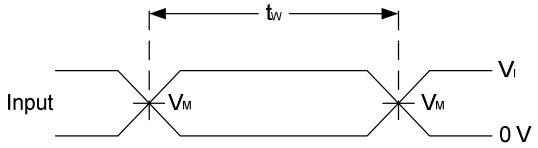
Note: 9. Test condition for each of the six package types: Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.

Parameter Measurement Information

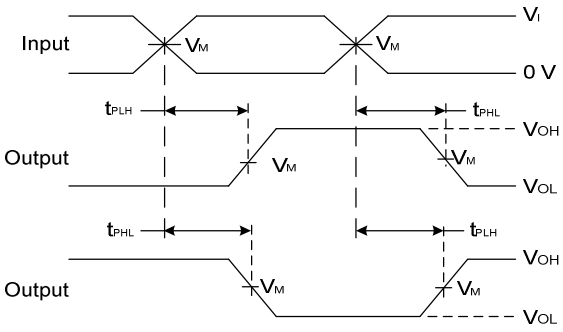


TEST	S1	R_L
t_{PLH}/t_{PHL}	Open	1MΩ
t_{PLZ}/t_{PZL}	Vload	5kΩ
t_{PHZ}/t_{PZH}	GND	5kΩ

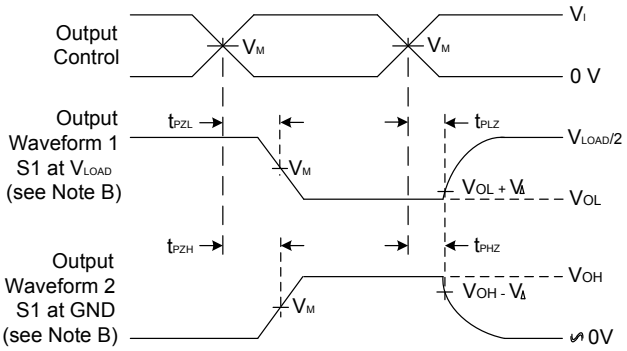
V_{CC}	Inputs		V_M	V_{LOAD}	C_L	V_Δ
	V_I	t_r/t_f				
0.8V	V_{CC}	≤3ns	$V_{CC}/2$	2 X V_{CC}	5, 10, 15, 30pF	0.1V
1.2V ± 0.1V	V_{CC}	≤3ns	$V_{CC}/2$	2 X V_{CC}	5, 10, 15, 30pF	0.1V
1.5V ± 0.1V	V_{CC}	≤3ns	$V_{CC}/2$	2 X V_{CC}	5, 10, 15, 30pF	0.1V
1.8V ± 0.15V	V_{CC}	≤3ns	$V_{CC}/2$	2 X V_{CC}	5, 10, 15, 30pF	0.15V
2.5V ± 0.2V	V_{CC}	≤3ns	$V_{CC}/2$	2 X V_{CC}	5, 10, 15, 30pF	0.15V
3.3V ± 0.3V	V_{CC}	≤3ns	$V_{CC}/2$	2 X V_{CC}	5, 10, 15, 30pF	0.3V



Voltage Waveform Pulse Duration



Voltage Waveform Propagation Delay Times
Inverting and Non Inverting Outputs



Voltage Waveform Enable and Disable Times
Low and High Level Enabling

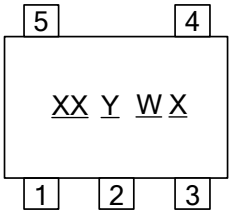
Figure 1 Load Circuit and Voltage Waveforms

Notes:
A. Includes test lead and test apparatus capacitance.
B. All pulses are supplied at pulse repetition rate ≤ 10MHz.
C. Inputs are measured separately one transition per measurement.
D. t_{PLZ} and t_{PHZ} are the same as t_{dis}.
E. t_{PZL} and t_{PZH} are the same as t_{EN}.
F. t_{PLH} and t_{PHL} are the same as t_{PD}.

Marking Information

(1) SOT353

(Top View)

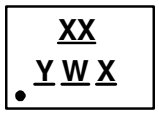


XX : Identification code
Y : Year 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents
52 and 53 week
X : A~Z : Internal code

Part Number	Package	Identification Code
74AUP1G126SE-7	SOT353	XZ

(2) X2-DFN0808-4, X2-DFN1010-6 X2-DFN1409-6 and X2-DFN1410-6

(Top View)

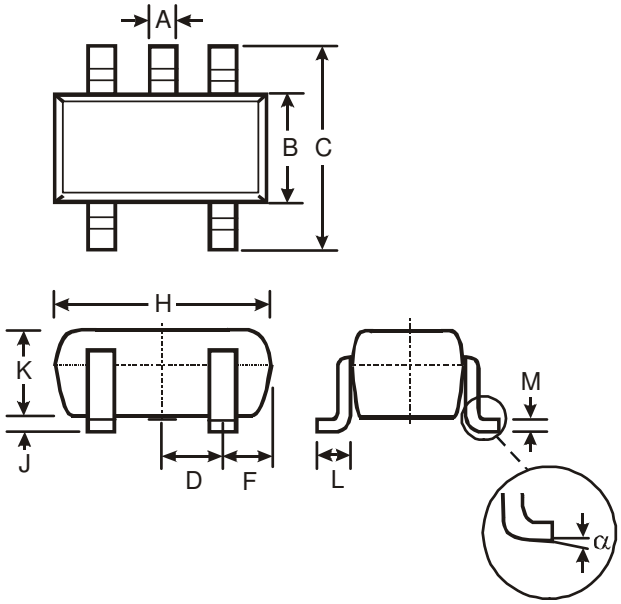


XX : Identification Code
Y : Year : 0~9
W : Week : A~Z : 1~26 week;
a~z : 27~52 week; z represents
52 and 53 week
X : A~Z : Internal code

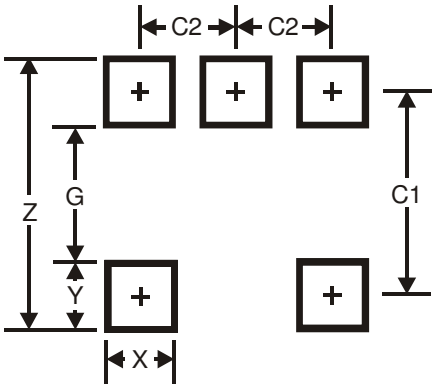
Part Number	Package	Identification Code
74AUP1G126FS3-7	X2-DFN0808-4	YZ
74AUP1G126FW5-7	X1-DFN1010-6	QY
74AUP1G126FW4-7	X2-DFN1010-6	XZ
74AUP1G126FX4-7	X2-DFN1409-6	HR
74AUP1G126FZ4-7	X2-DFN1410-6	XZ

SOT353 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



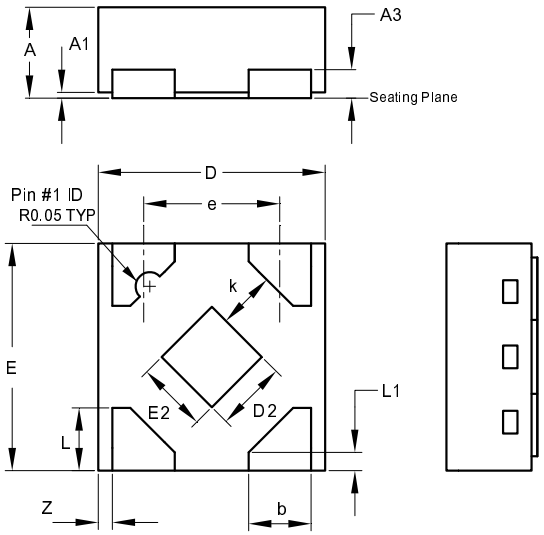
SOT353			
Dim	**Min**	**Max**	**Typ**
A	0.10	0.30	0.25
B	1.15	1.35	1.30
C	2.00	2.20	2.10
D		0.65 Typ	
F	0.40	0.45	0.425
H	1.80	2.20	2.15
J	0	0.10	0.05
K	0.90	1.00	1.00
L	0.25	0.40	0.30
M	0.10	0.22	0.11
α	0°	8°	-
All Dimensions in mm			



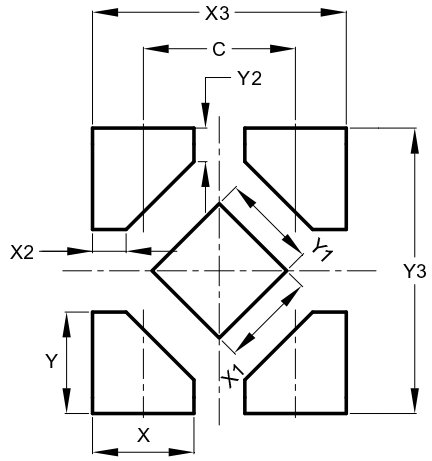
Dimensions	Value (in mm)
Z	2.5
G	1.3
X	0.42
Y	0.6
C1	1.9
C2	0.65

X2-DFN0808-4 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



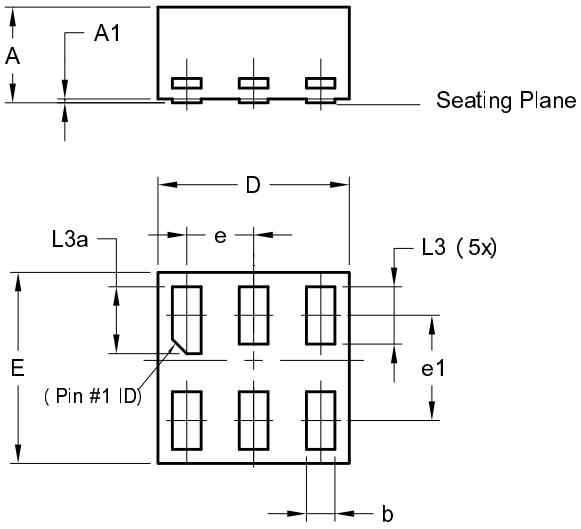
X2-DFN0808-4			
Dim	Min	Max	Typ
A	0.25	0.35	0.30
A1	0	0.04	0.02
A3	-	-	0.13
b	0.17	0.27	0.22
D	0.75	0.85	0.80
D2	0.15	0.35	0.25
E	0.75	0.85	0.80
E2	0.15	0.35	0.25
e	-	-	0.48
k	0.20	-	-
L	0.17	0.27	0.22
L1	0.02	0.12	0.07
z	-	-	0.05
All Dimensions in mm			



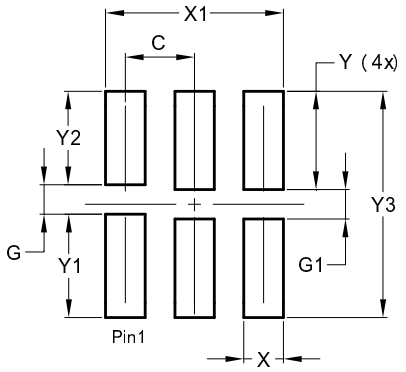
Dimensions	Value
C	0.480
X	0.320
X1	0.300
X2	0.106
X3	0.800
Y	0.320
Y1	0.300
Y2	0.106
Y3	0.900

X1-DFN1010-6 (Type B) Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



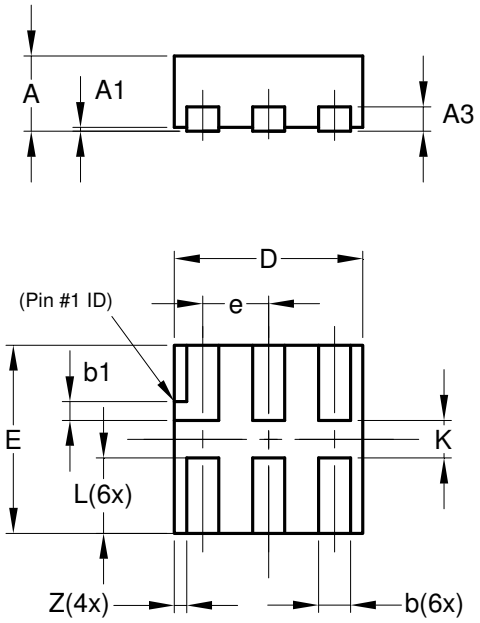
X1-DFN1010-6 (Type B)			
Dim	**Min**	**Max**	**Typ**
A	-	0.50	0.39
A1	-	0.04	-
b	0.12	0.20	0.15
D	0.95	1.050	1.00
E	0.95	1.050	1.00
e	0.35 BSC		
e1	0.55 BSC		
L3	0.27	0.30	0.30
L3a	0.32	0.40	0.35
All Dimensions in mm			



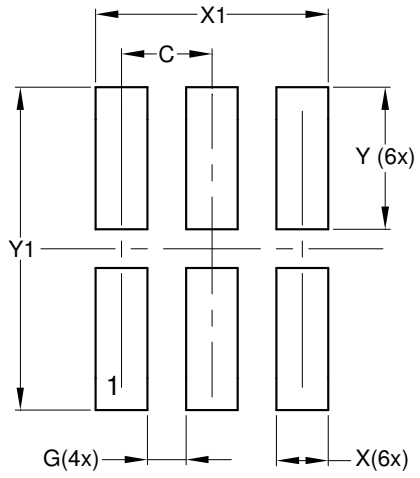
Dimensions	Value (in mm)
C	0.350
G	0.150
G1	0.150
X	0.200
X1	0.900
Y	0.500
Y1	0.525
Y2	0.475
Y3	1.150

X2-DFN1010-6 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



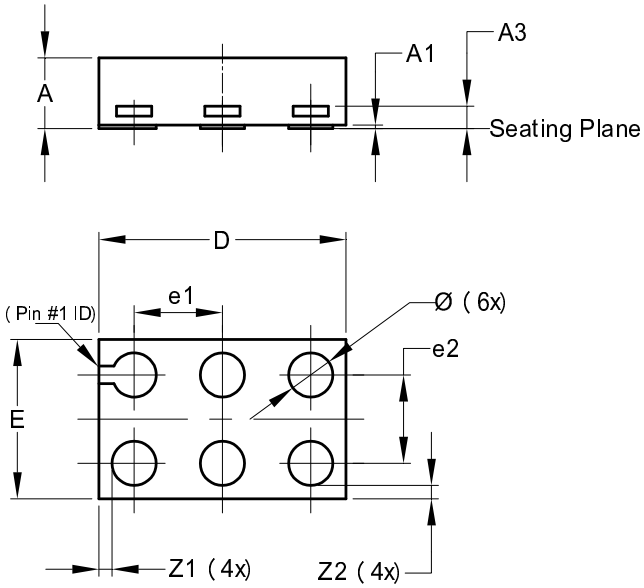
X2-DFN1010-6			
Dim	**Min**	**Max**	**Typ**
A	—	0.40	0.39
A1	0.00	0.05	0.02
A3	—	—	0.13
b	0.14	0.20	0.17
b1	0.05	0.15	0.10
D	0.95	1.05	1.00
E	0.95	1.05	1.00
e	—	—	0.35
L	0.35	0.45	0.40
K	0.15	—	—
Z	—	—	0.065
All Dimensions in mm			



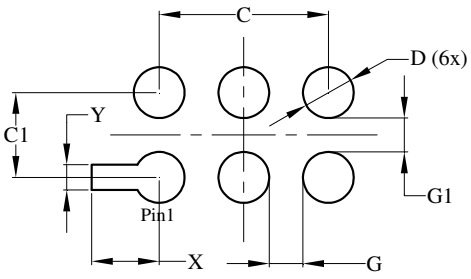
Dimensions	Value (in mm)
C	0.350
G	0.150
X	0.200
X1	0.900
Y	0.550
Y1	1.250

X2-DFN1409-6 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



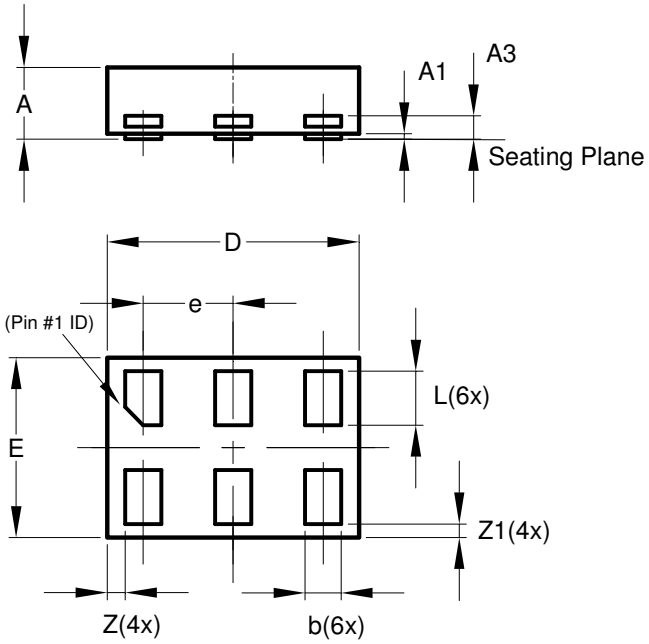
X2-DFN1409-6			
Dim	**Min**	**Max**	**Typ**
A	-	0.40	0.39
A1	0	0.05	0.02
A3	-	-	0.13
Ø	0.20	0.30	0.25
D	1.35	1.45	1.40
E	0.85	0.95	0.90
e1	-	-	0.50
e2	-	-	0.50
Z1	-	-	0.075
Z2	-	-	0.075
All Dimensions in mm			



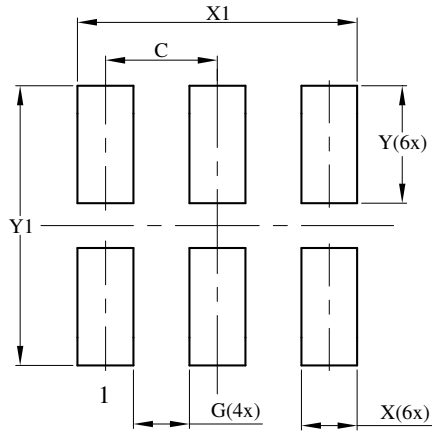
Dimensions	Value (in mm)
C	1.000
C1	0.500
D	0.300
G	0.200
G1	0.200
X	0.400
Y	0.150

X2-DFN1410-6 Package Outline Dimensions and Suggested Pad Layout

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.



X2-DFN1410-6			
Dim	**Min**	**Max**	**Typ**
A	—	0.40	0.39
A1	0.00	0.05	0.02
A3	—	—	0.13
b	0.15	0.25	0.20
D	1.35	1.45	1.40
E	0.95	1.05	1.00
e	—	—	0.50
L	0.25	0.35	0.30
Z	—	—	0.10
Z1	0.045	0.105	0.075
All Dimensions in mm			



Dimensions	Value (in mm)
C	0.500
G	0.250
X	0.250
X1	1.250
Y	0.525
Y1	1.250

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